

Eragon 624 SOM | Development Kit



Based on the Qualcomm® Snapdragon™ 624 Processor (SDA 624)



eragon

624

Subject to change without prior Notice

About eInfochips

eInfochips is product engineering services company offering technology consulting and product design services in multiple industry verticals like aerospace and defense, security and surveillance, medical and healthcare, industrial and home Automation, consumer electronics and more.

eInfochips is a Qualcomm Snapdragon Technology Partner (STP) offering turnkey product designs on multiple Snapdragon SoCs and have enabled global customers with Qualcomm based product designs.

Engineering Highlights

- 20+ Years of experience in system design
- 1700+ Engineering professionals
- 10 Design centers spread across USA & India
- 500+ Product designs
- 35+ Product designs on Qualcomm
- 15M+ Product deployments across globe
- ISO 9001 and CMMi L3 compliant processes

eInfochips Eragon 624

Eragon 624 is a System-on-Module (SoM) based on Qualcomm® Snapdragon™ 624 (SDA 624) System on Chip (SoC) and offers premium 1080p90 video support with HEVC capture and playback. Eragon 624 offers unmatched power efficiency and is an ideal choice for battery operated product designs. The SoM can be further customized by eInfochips to match specific customer requirements.

Eragon 624 Development Kit is the combination of SoM and carrier board that enables OEMs and engineers to evaluate performance of Snapdragon 624 for their product designs and helps them to accelerate their time to market.

Home Automation

UAV and Robotics

4K Cameras

Human Machine Interface
(HMI)

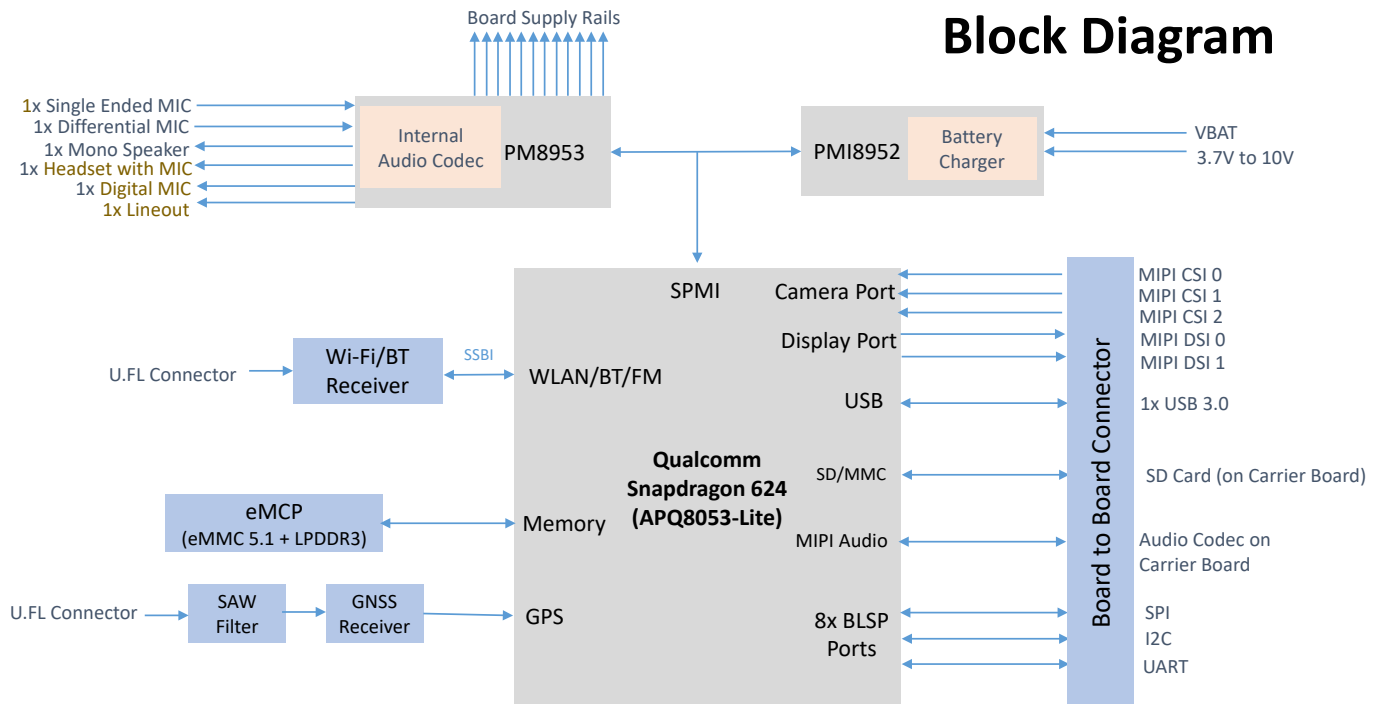
Medical Imaging

Machine Vision

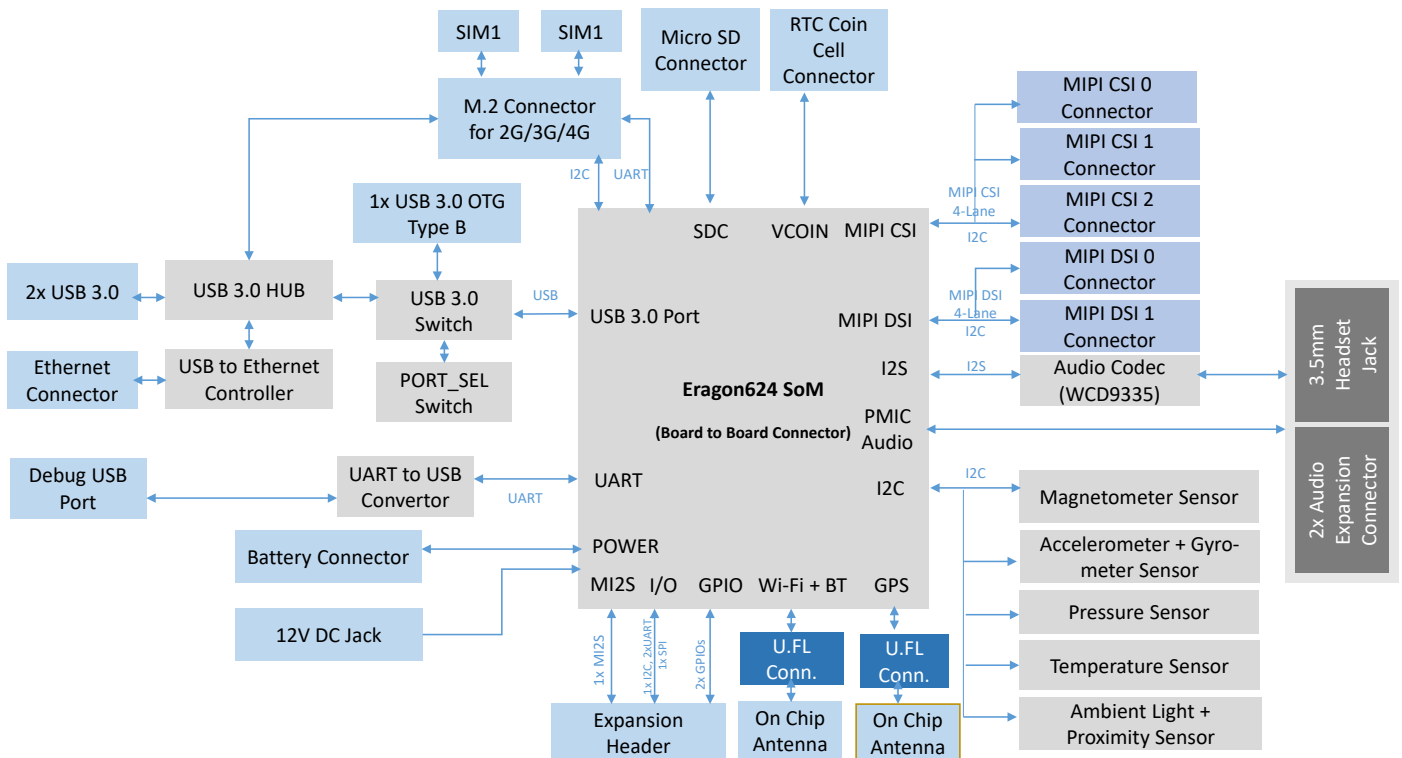
Video Conferencing Systems

Industrial IOT

System on Module Block Diagram



Development Kit Block Diagram





Datasheet Rev 1.0

Processor

- Qualcomm® Snapdragon 624 (APQ8053-Lite-1.8GHz)
- Power Management IC with Battery Support

Memory and Storage

- 3GB LPDDR3, 32GB eMMC 5.1 (eMCP)
- MicroSD

Connectivity

Wi-Fi

- Qualcomm® Wi-Fi 802.11a/b/g/n/ac 2.4/5Ghz
- Antenna – U.FL connectors on SOM; Chip Antenna on Carrier Card (SOM to Carrier Card Connection via U.FL cable)

Bluetooth

- Bluetooth 4.2 (Classic & BLE)

Location

- GPS (GNSS, GLONASS)
- U.FL connector on SOM, Chip Antenna on Carrier Card (SOM to Carrier Card Connection via U.FL Cable)

- Optional- M.2 based 4G LTE Module Support

USB

- 2x USB 3.0 via USB 3.0 Hub
- 1x Ethernet via USB 3.0 Hub (100/1000Mbps)
- USB 3.0 OTG via USB 3.0 Switch (Mutually exclusive with 2x USB 3.0 and 1x Ethernet)

Audio (Built-in or Discrete (default))

- Built-in Audio Codec Support (PMIC) – On Header
 - 1x Single ended MIC
 - 1x Headset with MIC
 - 1x Differential MIC
 - 1x Digital MIC
 - 1x Lineout
 - 1x Mono speaker

- Discrete Qualcomm® Audio Codec Support
 - 2x Speaker Interface Outputs
 - 5x Analog MIC
 - 3x Digital MIC
 - 1x 3.5mm Audio Jack with MIC
 - 1x Ear-piece
 - 2x Line-out

Camera

- 3x 4-lane MIPI-CSI Ports (2x Simultaneous support)
- Support for 16MP and 13 MP Image Sensors

Display

- 2x 4-lane MIPI-DSI
- eInfochips Display Adapter Card Support (1080p)
- Full HD (1920 x 1080) 60 fps; 16/18/24 bpp RGB
- Wi-Fi Display (WFD): 1080p30

Video

Encode

- Supported Formats: H.265 (HEVC), H.264 and VP8
- Supported Resolution: 1080p @ 90fps, 1080p @ 60 fps (H.264, H.265, VP8)

Decode

- Supported formats: H.264, H.265, VP8, and VP9
- Supported Resolution: 3840x2160 (4K) @ 30 fps (H.264, H.265), 1080p @ 60 fps (H.264, H.265, VP8)

Sensors

- 1x Accelerometer and Gyroscope
- 1x Magnetometer
- 1x Ambient Light & Proximity Sensor
- 1x Temperature Sensor
- 1x Pressure Sensor

Others

- 2x UART, 1x SPI, 1x I2C, 2x GPIO, 2x I2S provided on expansion header
- 1x 4K HDMI Input Support via a HDMI to CSI add-on board
- 1x DSI to HDMI 1.4b (1080p30) Adapter Card

Power specification

- Power supply input: 12V/5A input from 12V DC Power Adapter (included in kit)
- Optional - Battery Support - 3.7V Li-Po Battery

Mechanical specification

- SOM - 60mm x 35mm
- CARRIER - 120mm x 130mm

Temperature Specification

- Operating Temperature Range: -30°C to +85°C

Operating System

- Android 8.1
- Linux (Planned)

Kit Contents

- 1x System on Module based on Snapdragon 624
- 1x Carrier Board
- 1x LCD (MIPI-DSI, 1080p)
- 1x Audio Board (Using Qualcomm WCD9335 Audio Codec)
- 1x Base Plate
- 1x Power Adapter
- 1x Ethernet Cable
- 1x USB Cable
- 1x Quick Start Guide

Add-on Accessories

- Camera Board

Orderable Part

- SOM:** EIC-Q624-200
- Development Kit:** EIC-Q624-210
- Camera Board:** EIC-Q624-CAM

WCN36808 WGR7640, WCD9335, PMI8952, PM8953, Qualcomm Hexagon, Qualcomm Adreno and Qualcomm Kryo are products of Qualcomm Technologies, Inc. and/or its subsidiaries.

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